



Title of Change:	Update to FPCN21496Z1 - Assembly & Test site transfer of SMA products currently manufactured in ON Semiconductor Malaysia facility (SBN) to ON Semiconductor Vietnam (OSV) facility.	
Proposed Changed Material First Ship Date:	08 November 2017 (OSV parts available for earlier conversions)	
Current Material Last Order Date:	07 August 2017 Orders received after the Current Material Last Order Date expiration are to be considered as orders for new changed material as described in this PCN. Orders for current (unchanged) material after this date will be per mutual agreement and current material inventory availability.	
Current Material Last Delivery Date:	07 November 2017 The Current Material Last Delivery Date may be subject to change based on build and depletion of the current (unchanged) material inventory.	
Product Category:	Active components – Discrete components	
Contact information	Contact your local ON Semiconductor Sales Office or <Phuong.Hoang@onsemi.com>	
Samples	Contact your local ON Semiconductor Sales Office to place sample order. Sample requests are to be submitted no later than 45 days after publication of this change notification.	
Sample Availability Date:	Samples Available On Request	
PPAP Availability Date:	PPAP Available On Request	
Additional Reliability Data	Contact your local ON Semiconductor Sales Office or <cheanching.sim@onsemi.com >.	
Type of Notification	This is an update to a Final Product/Process Change Notification (FPCN) sent to customers. ON Semiconductor will consider this proposed change and it's conditions acceptable, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <PCN.Support@onsemi.com>.	
Change Category	Type of Change	
Process – Assembly	Move of all or part of assembly to a different location/site/subcontractor.	
Process – Assembly	Change of product marking	
Test Flow	Move of all or part of electrical wafer test and/or final test to a different location/site/subcontractor	
Equipment	Production from a new equipment/tool which uses the same basic technology (replacement equipment or extension of existing equipment pool) without change of process.	
Description and Purpose:		
FPCN21496Z1 was previously issued to clarify that the listed SMA products will be transferred to OSV. However the dates reflected in that said notice was incorrect.		
This Update Notification is issued to correct the dates as the timing of change should still be based on to the original FPCN21496Z:		
	From	To
Proposed Changed Material First Ship Date:	<i>07 June 2018</i>	<i>08 November 2017</i>
Current Material Last Order Date:	<i>31 March 2018</i>	<i>07 August 2017</i>
Current Material Last Delivery Date:	<i>31 May 2018</i>	<i>07 November 2017</i>
Risks for delayed conversion:	<i>No Seremban supply after Dec 31, 2017</i>	<i>No Seremban supply after Dec 1st, 2017</i>



Reason / Motivation for Change:	<ul style="list-style-type: none"> • Change benefits for customer(s): <ul style="list-style-type: none"> ○ Unconstrained Automotive Sourcing; Mfg floor space for future expansion ○ Sustained TS16949 Certification with the Same BOM / Equipment / Processes ○ Allow for increased support for Seremban packages that are currently constrained ○ OSV has been audited to VDA6.3 • Risks for delayed conversion: <ul style="list-style-type: none"> ○ No Seremban supply after Dec 1st, 2017 ○ Limited ability to support bridge build availability.
Anticipated impact on fit, form, function, reliability, product safety or manufacturability	No anticipated impacts. The device(s) has been qualified and validated based on the same Product Specification. The device(s) has successfully passed the AEC-Q101 qualification tests. Potential impacts can be identified, but due to testing performed by ON Semiconductor in relation to the PCN, associated risks are verified and excluded.
Sites Affected: <input type="checkbox"/> All site(s) <input type="checkbox"/> not applicable <input checked="" type="checkbox"/> ON Semiconductor site(s) : <input type="checkbox"/> External Foundry/Subcon site(s) <i>ON Seremban, Malaysia</i> <i>ON Dong Nai Province, Vietnam</i>	
Marking of Parts/ Traceability of Change:	Product from ON Semiconductor Vietnam (OSV) will be marked with site code "VN" prior to the date code while the Seremban device will not reflect a site code marking.
Reliability Data Summary: No Changes. Successfully Passed AEC-Q101 Qualification. Please refer to original FPCN	
Electrical Characteristic Summary: No Changes. Electrical characteristics are not impacted. Please refer to original FPCN	
List of Affected Standard Parts:	
Transferring Malaysia (SBN) Part Number	Qualification Vehicle
SURA8110T3G	MURA260T3G
SURA8120T3G	
SURA8140T3G	
SURA8160T3G	
SURA8210T3G	
SURA8220T3G	
SZ1SMA5935BT3G	1SMA5945BT3G